

# **SPECIFICATION**

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SPEC. NO.: PS-50620-XXXXX-XXX REVISION: F

PRODUCT NAME: 0.5/1.0 mm Pitch NON-ZIF FPC Conn. SMT R/A D/C

PRODUCT NO: 50620 ,50636 ,50676 ,50678 ,50679 ,51520 ,51640,

**52535 Series** 

PREPARED: CHECKED: APPROVED:

RONG LI PING ANDREW HSIEH, FU YU

DATE: DATE:

2020.12.15 2020.12.15 2020.12.15



# Aces P/N: 50620 50636 50676 50678 50679 51520 51640 52535 Series

TITLE: 0.5/1.0mm Pitch NON-ZIF FPC Conn. SMT R/A D/C Type

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# 1 Revision History

Rev.	ECN#	Revision Description	Prepared	Date
0	ECN-0812063	NEW SPEC	Ryan	2008.11.10
A	ECN-0906034	ADD 50676 50678 50679 Series	Huamin	2009.06.04
В	ECN-1009111	ADD 51520 Series	Andrew	2010.09.18
С	ECN-1401269	ADD WORKING VOLTAGE	XUFEI	2014.01.15
D	ECN-1406159	ADD 51520-XXXXX-V01	GUKEQING	2014.06.12
Е	ECN-1503303	ADD 51640 Series	LLJ	2015.04.14
F	ECN-000909	ADD 52535 Series	RONG LIPING	2020.12.15
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#### 2 SCOPE

This specification covers performance, tests and quality requirements for 0.5mm Pitch NON-ZIF FPC Connector. These connectors are used to hold graphic card in DSC.

Aces's P/N : 50636-XXXXX-XXX

50620-XXXXX-XXX; 51520-XXXXX-XXX 50676-XXXXX-XXX 51520-XXXXX-V01 50678-XXXXX-XXX 51640-XXXXX-XXX

50679-XXXXX-XXX

#### 3 APPLICABLE DOCUMENTS

EIA-364 ELECTRONICS INDUSTRIES ASSOCIATION

#### **4 REQUIREMENTS**

4.1 Design and Construction

Product shall be of design, construction and physical dimensions specified on applicable product drawing.

- 4.2 Materials and Finish
  - 4.2.1 Contact: High performance copper alloy.

Finish: Plating pls. See the product drawing.

- 4.2.2 Housing: Thermoplastic High Temp., UL94V-0
- 4.2.3 Nut or Ear: Copper Alloy, Plating pls. See the product drawing.
- 4.3 Ratings
  - 4.3.1 Working voltage less than 36 volts (per pin)
  - 4.3.2 Voltage: 50 Volts AC (per pin)
  - 4.3.3 Current: 0.5 Amperes (per pin)
  - 4.3.4 Operating Temperature : -40°C to +85°C



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#### 5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard		
Examination of Product	Product shall meet requirements of applicable product drawing and			
Examination of Product	specification.	per applicable quality inspection plan.		
	ELECTRICAL			
Item	Requirement	Standard		
Low Level Contact Resistance	$55$ m $\Omega$ Max.(initial)per contact $20$ m $\Omega$ Max. Change allowed	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)		
Insulation Resistance	50 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)		
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	250 VAC Min. at sea level for 1 minute, Test between adjacent contacts of unmated connectors. (EIA-364-20)		
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)		
	MECHANICAL	- , ,		
Item	Requirement	Standard		
Durability	20 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)		
Contact Retention Force	0.15 kgf Min.	Operation Speed:  25.4 ± 3 mm/minute.  Measure the contact retention force with Tensile strength tester.		
FPC Insertion/Withdrawal Force	Refer to FPC Insertion/ withdrawal force	Insert the FPC, pull the FPC at the speed rate of 25.4 ± 3 mm/min. See 8. FPC Retention Force.		
Fitting Nail /Housing Retention Force	0.15 kgf MIN.	Apply axial pull out force at the speed rate of 25.4 ± 3 mm/minute. On the fitting nail assembled in the housing.		



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Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A)

ENVIRONMENTAL							
Item	Requirement	Standard					
Resistance to <b>Reflow</b>	See Product Qualification and Test	Pre Heat : 150°C~180°C, 60~90sec. Heat : 230°C Min., 40sec Min. Peak Temp. :					
Soldering Heat	Sequence Group 9 (Lead Free)	260°CMax, 10sec Max. See 6.1 Lead free process					
Thermal Shock	See Product Qualification and Test Sequence Group 3	Mate module and subject to follow condition for 5 cycles.  1 cycles: -40 +0/-3 °C, 30 minutes					
		+85 +3/-0 °C, 30 minutes (EIA-364-32, test condition A)					
Humidity	See Product Qualification and Test Sequence Group 3	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)					



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		Subject mated connectors to	
Temperature life	See Product Qualification and Tes	temperature life at 85°C for 96	
	Sequence Group 4	hours (EIA-364-17, Test condition A)	
		Subject mated/unmated	
Salt Spray	See Product Qualification and Tes	t connectors to 5% salt-solution	
Sait Spray	Sequence Group 5	concentration, 35°C for 8 hours. (EIA-364-26,Test condition B)	
Solder ability	Solder able area shall have minimum of 95% solder coverage.	Subject the test area of contacts into the flux for 5-10 sec. And then into solder bath, Temperature at	
	minimum of 93 % solder coverage.	245 ±5°C, for 4-5 sec. (EIA-364-52)	
	Hand Soldering temperature:	Contact Resistance:	
Hand Soldering	350±5°C (base on MIL-STD-202,	40 mohms max.	
	method 208)	TO MOMINO MAX.	

**Note.** Flowing Mixed Gas shell be conduct by customer request.



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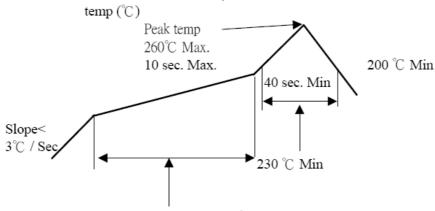
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#### **6 INFRARED REFLOW CONDITION**

6.1. Lead-free Process

# TEMPERATURE CONDITION GRAPH ( TEMPERATURE ON BOARD PATTERN SIDE )



Pre-heat Hold time for  $150 \sim 180$  °C is  $60 \sim 120$  sec.

(reflow 2 cycles)



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### 7 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group									
Test or Examination		2	3	4	5	6	7	8	9	10
				,	Test Se	quenc	e			
Examination of Product	1 \ 3	1 . 8	1 . 7	1 . 6	1 • 4				1	
Low Level Contact Resistance		2 \ 11	2 \ 10	2、9	2 . 5				3	1 • 4
Insulation Resistance		3 \ 10	3、9	3 . 8						
Dielectric Withstanding Voltage		4 . 9	4 \ 8	4 . 7						
Temperature rise	2									
Durability		6								
Vibration										2
Shock (Mechanical)										3
Thermal Shock			5							
Humidity			6							
Temperature life				5						
Salt Spray					3					
Solder ability						1				
Contact Retention Force							1			
FPC Insertion/Withdrawal Force		5 \ 7								
Fitting Nail /Housing Retention Force								1		
Resistance to Soldering Heat									2	
Sample Size	2	4	4	4	4	2	4	4	4	4



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#### 8 FPC Insertion/Withdrawal Force

NO. OF	Inserti	on Force ( Kg	gf, Max )	Withdra	awal Force ( Kgf	f, Min )	
Ckt.	1st	6th	20th	1st	6th	20th	
4~9	1.30	1.20	1.10	0.30	0.22	0.20	
10~14	1.35	1.17	1.00	0.30	0.24	0.22	
15~24	2.30	2.00	1.70	0.48	0.37	0.34	
25~36	3.45	3.00	2.55	0.82	0.61	0.57	
37~50	4.80	4.17	3.55	1.22	0.90	0.85	